



40V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)}	I _D T _C = +25°C
40V	2.5mΩ @ V _{GS} = 10V	167A
400	$3.7 \text{m}\Omega$ @ V _{GS} = 4.5V	137A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

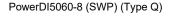
- DC-DC converters
- Load switches

Features

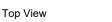
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Thermally Efficient Package Cooler Running Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 63
- Weight: 0.097 grams (Approximate)

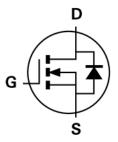




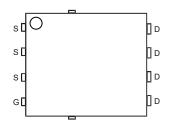




Bottom View



Internal Schematic



Top View Pin Configuration

Ordering Information (Note 4)

Orderable Part Number	Dookses	Packing		
Orderable Part Number	Package	Qty.	Carrier	
DMTH42M6LPSW-13	PowerDI5060-8 (SWP) (Type Q)	2500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



⊃ ! ! = Manufacturer's Marking TH42M6LSW = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 25 = 2025) WW = Week (01 to 53)

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Maximum Ratings (@T_C = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	40	V
Gate-Source Voltage			V_{GSS}	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 6)	Steady State	T _C = +25°C T _C = +100°C	lo	167 118	А
Maximum Continuous Body Diode Forward Current (Note 6)			Is	167	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	668	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			lsм	668	Α
Avalanche Current, L = 1mH			las	16.6	Α
Avalanche Energy, L = 1mH			E _{AS}	141	mJ

Thermal Characteristics (@Tc = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	4.3	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	35	°C/W	
Total Power Dissipation (Note 6)	T _C = +25°C	P _D	125	W
Thermal Resistance, Junction to Case (Note 6)		Rелс	1.2	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@Tc = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	40		_	V	$V_{GS} = 0$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	1	1	μΑ	$V_{DS} = 32V, V_{GS} = 0$	
Gate-Source Leakage	Igss	_		±100	nΑ	$V_{GS} = \pm 20V, V_{DS} = 0$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	1		2.5	٧	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	C	_	2.0	2.5		V _{GS} = 10V, I _D = 20A	
Static Drain-Source On-Resistance	RDS(ON)	_	2.9	3.7	mΩ	$V_{GS} = 4.5V, I_D = 20A$	
Diode Forward Voltage	VsD	_	0.8	1.0	V	V _{GS} = 0, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	2213	_		V _{DS} = 20V, V _{GS} = 0, f = 1MHz	
Output Capacitance	Coss	_	1403	_	pF		
Reverse Transfer Capacitance	Crss	_	66	_			
Gate Resistance	Rg	_	1.9	_	Ω	$V_{DS} = 0$, $V_{GS} = 0$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 10V)	Qg	_	31	_			
Gate-Source Charge	Qgs	_	7.9	_	nC	V _{DS} = 20V, I _D = 20A, V _{GS} = 10V	
Gate-Drain Charge	Qgd	_	3.9	_		!	
Turn-On Delay Time	t _D (ON)	_	6.1	_		$V_{DD} = 20V, V_{GS} = 10V,$ $I_{D} = 20A, R_{G} = 1.6\Omega$	
Turn-On Rise Time	t _R	_	6.0	_			
Turn-Off Delay Time	t _{D(OFF)}	_	24.3	_	ns		
Turn-Off Fall Time	t _F	_	12.9	_			
Body Diode Reverse-Recovery Time	t _{RR}	_	38.8	_	ns	lo = 15A di/dt = 100A/uc	
Body Diode Reverse-Recovery Charge	Q _{RR}	_	38.4	_	nC	I _S = 15A, di/dt = 100A/μs	

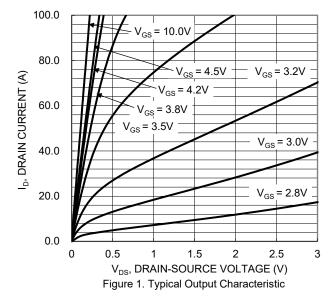
Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to production testing.





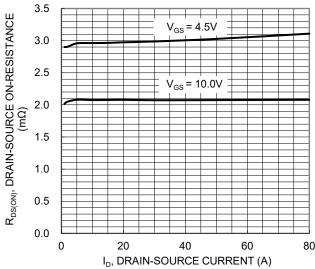


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

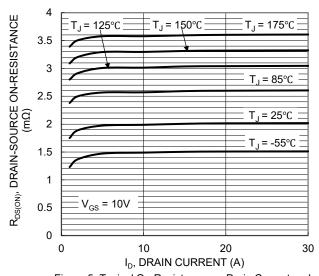


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

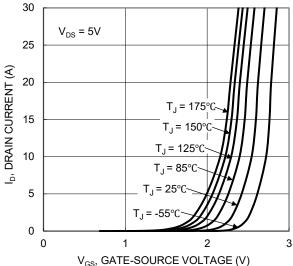


Figure 2. Typical Transfer Characteristic

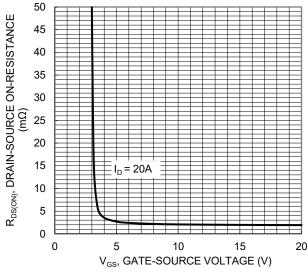


Figure 4. Typical Transfer Characteristic

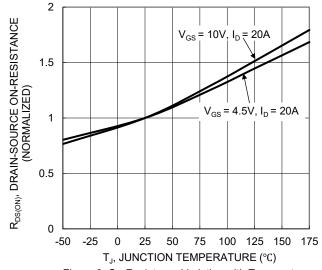


Figure 6. On-Resistance Variation with Temperature



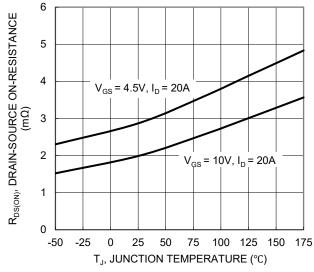


Figure 7. On-Resistance Variation with Temperature

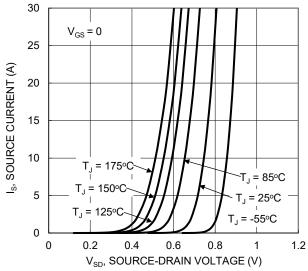


Figure 9. Diode Forward Voltage vs. Current

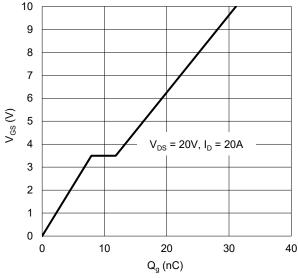


Figure 11. Gate Charge

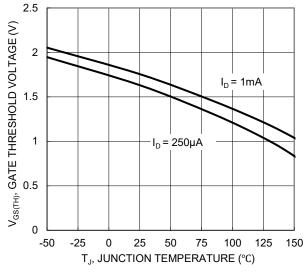
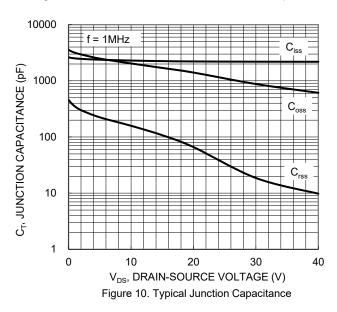


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 100 ID, DRAIN CURRENT (A) = 10µs $P_{W} = 100 \mu s$ 10 P_W = 1ms P_W = 10ms T_{J(Max)} = 175℃ P_W = 100ms T_C = 25℃ Single Pulse DC DUT on Infinite Heatsink $V_{GS} = 10V$ 0.1 0.1 10 100 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



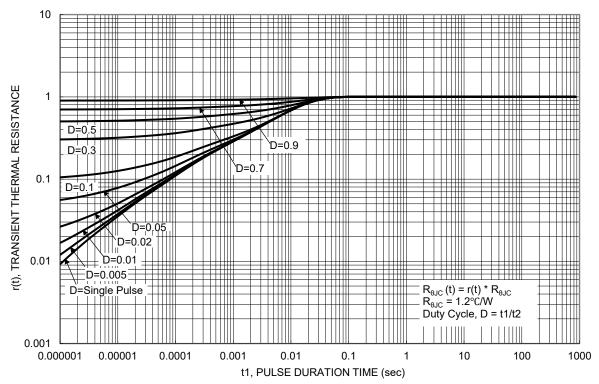


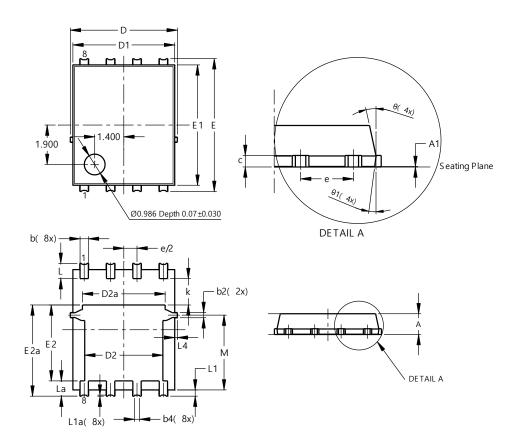
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type Q)

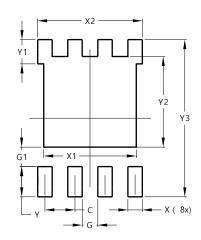


PowerDI5060-8 (SWP) (Type Q)				
Dim	Min Max		Тур	
Α	0.90	1.10	1.00	
A1	0	0.05	-	
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	().25REF	•	
С	0.230	0.330	0.277	
D	5	.15 BS0	2	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
Е	6	.40 BS0	2	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1	.27BSC)	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
M	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type Q)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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DMTH42M6LPSW
Document number: DS47229 Rev. 2 - 2